

1-2178710-0 ✓ ACTIVE

[Micro-MaTch](#) | [Micro-MaTch Value Line](#)

TE Internal #: 1-2178710-0

Ribbon Cable Connectors, Board-to-Board, 10 Position, 1.27 mm [.05 in] Centerline, Vertical, Through Hole - Solder, 2 Row, Micro-MaTch Value Line

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FEMALE-ON-BOARD CON TOP ENTRY VALUE-LINE



Connector System: **Board-to-Board**

Number of Positions: **10**

Centerline (Pitch): **1.27 mm [.05 in]**

PCB Mount Retention: **With**

PCB Mount Retention Type: **Kinked Solder Tails**

[All FEMALE-ON-BOARD CON TOP ENTRY VALUE-LINE \(1\)](#)

## Features

### Product Type Features

Connector Type	Connector Assembly
Ribbon Cable Connector Type	Female-on-Board
Ribbon Cable Connector Header Type	Shrouded
Connector Product Type	Connector Assembly
Connector System	Board-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board

### Configuration Features

Number of Positions	10
PCB Mount Orientation	Vertical
Number of Rows	2

### Electrical Characteristics

Insulation Resistance	1000 MΩ
Operating Voltage	100 VAC

### Body Features

Daisy Chain	Without
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Connector Profile Standard

### Contact Features

PCB Contact Termination Area Plating Material Thickness	3 – 5 $\mu\text{m}$ [118.11 – 196.85 $\mu\text{in}$ ]
Contact Type	Socket
Contact Mating Area Plating Material Thickness	3 – 5 $\mu\text{m}$ [118.11 – 196.85 $\mu\text{in}$ ]
Contact Mating Area Plating Material	Tin
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.85 A

### Termination Features

Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

### Mechanical Attachment

Mating Alignment	With
Contact Retention Type Within Housing	Press-Fit
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Kinked Solder Tails
Mating Retention	With
Mating Retention Type	Contact Friction
Connector Mounting Type	Board Mount

### Housing Features

Mating Entry Location	Top
Housing Material	PBT GF
Housing Color	Black
Centerline (Pitch)	1.27 mm[.05 in]

### Dimensions

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Connector Length	14.7 mm[.578 in]
Connector Height	4 mm[.16 in]
PCB Thickness (Recommended)	1.6 mm[.062 in]
Row-to-Row Spacing	2 mm[.059 in]

### Usage Conditions

Operating Temperature Range	-30 – 85 °C[-22 – 185 °F]
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### Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

### Industry Standards

UL Rating	Recognized
Agency/Standard	UL
UL File Number	E28476
UL Flammability Rating	UL 94V-0

### Packaging Features

Packaging Quantity	2500
Packaging Method	Reel

### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

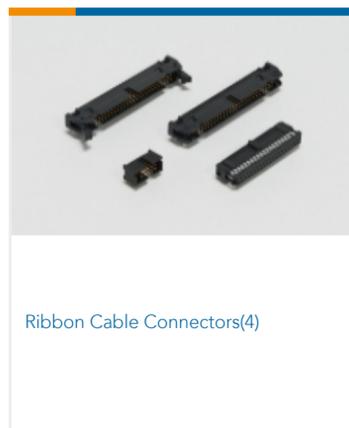
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts



## Also in the Series | Micro-MaTch Value Line



## Documents

### CAD Files

[3D PDF](#)

[3D](#)

[Customer View Model](#)

[ENG\\_CVM\\_CVM\\_1-2178710-0\\_A.2d\\_dxf.zip](#)

English

[Customer View Model](#)

[ENG\\_CVM\\_CVM\\_1-2178710-0\\_A.3d\\_igs.zip](#)

English

[Customer View Model](#)

[ENG\\_CVM\\_CVM\\_1-2178710-0\\_A.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

## Datasheets & Catalog Pages



[1-1773840-5\\_MICRO-MATCH-VALUE-LINE-QRG](#)

English

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**Product Specifications**

[Product Specification](#)

English

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**Product Environmental Compliance**

[Product Compliance](#)

English

[Product Compliance](#)

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